


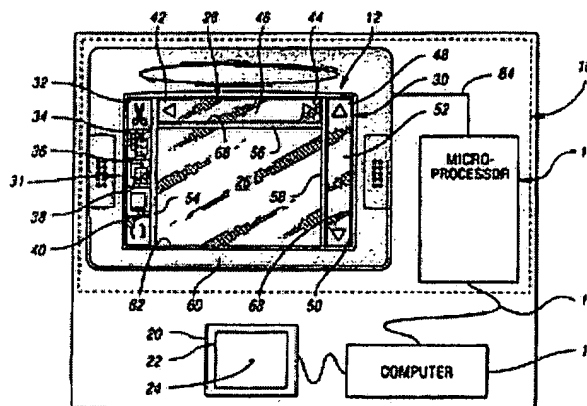


FORCE SENSING SEMICONDUCTIVE TOUCHPAD**Patent number:** WO9806079**Publication date:** 1998-02-12**Inventor:** MARTINELLI JOHN K; MARTINELLI ROBERT M;
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STUART J**Applicant:** INTERLINK ELECTRONICS (US)**Classification:****- international:** G08C21/00; G09G3/02**- european:** G06F3/033Z4S6, G06F3/033Z8D5, G06F3/033D,
G06F3/033D2**Application number:** WO1997US13714 19970804**Priority number(s):** US19960023168P 19960805; US19970857134
19970515**Also published as:** US5943044 (A1)**Cited documents:** US5402151 US5369227 US5602570**Abstract of WO9806079**

A touchpad assembly (10) and method for providing a signal to a computer (16) indicative of the location and applied pressure of an object touching the touchpad assembly is provided. The touchpad assembly includes X and Y position and pressure sensitive semiconductor resistance sensor layers. The X and Y sensors have a pair of spaced apart X and Y conductive traces running across opposite ends.



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